

Product Summary

Device	BV _{DSS}	RDS(ON) Max	I _{D MAX} Та = +25°С
Q1	20V	$25m\Omega @ V_{GS} = 4.5V$	6.0A
N-Channel	200	35mΩ @ VGS = 2.5V	5.1A
Q2	2017	75mΩ @ VGs = -4.5V	-3.5A
P-Channel	-20V	140mΩ @ V _{GS} = -2.5V	-2.5A

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP, and is ideal for use in:

U-DFN2020-6 (Type B)

- Load Switch
- Power Management Functions
- Portable Power Adaptors

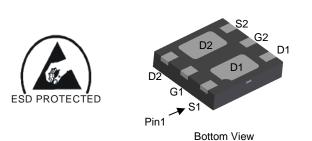
Features

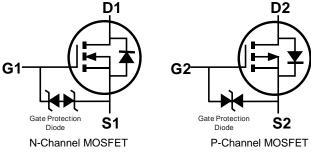
- PCB Footprint of 4mm²
- Low On-Resistance
- Low Input Capacitance
- Low Profile, 0.6mm Maximum Height
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMC2025UFDBQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: U-DFN2020-6
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @4
- Terminals Connections: See Diagram Below
- Weight: 0.0065 grams (Approximate)





Internal Schematic

Ordering Information (Note 4)

Part Number	Case	Packaging
DMC2025UFDBQ-7	U-DFN2020-6 (Type B)	3,000/Tape & Reel
DMC2025UFDBQ-13	U-DFN2020-6 (Type B)	10,000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

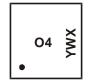
2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information



O4 = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 1 = 2021) W = Week (ex: a = Week 27; z Represents Week 52 and 53)

X = Internal Code (ex: U = Monday)

Year	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	1	2	3	4	5	6	7	8	9	0	1	2
Week	1-26			27-52			53					
Code		A	-Z		a-z			Z				
Internal Code	Su	ın	Mor	า	Tue	1	Wed	Thu	1	Fri		Sat
Code		Г	U		V		W	Х		Y		7

Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic			Symbol	Q1 N-CHANNEL	Q2 P-CHANNEL	Unit
Drain-Source Voltage				20	-20	V
Gate-Source Voltage			Vgss	±10	±8	V
Continuous Drain Current (Note 6) N-Channel: V _{GS} = 4.5V P-Channel: V _{GS} = -4.5V	Steady State	T _A = +25°C T _A = +70°C	ID	6.0 4.8	-3.5 -2.8	А
Maximum Continuous Body Diode Forward Current (Note 6)			ls	2	-1.0	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	20	-10	А
Avalanche Current (L = 0.1mH) (Note 7)				8	-13	А
Avalanche Energy (L = 0.1mH) (Note 7)			E _{AS}	8	8.5	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	0.7	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _{OJA}	178	°C/W
Total Power Dissipation (Note 6)	T _A = +25°C	PD	1.4	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R _{OJA}	92	°C/W
Thermal Resistance, Junction to Case (Note 6)		Rejc	30	C/VV
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

 Device mounted on FR-4 substrate PCB, 2oz copper, with minimum recommended pad layout.
Device mounted on FR-4 substrate PCB, 2oz copper, with 1inch square copper plate. Notes:

7. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_J = +25^{\circ}C$.



Electrical Characteristics Q1 N-CHANNEL (@ T_A = +25°C, unless otherwise specified.)

			_			
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)	-			1	1	
Drain-Source Breakdown Voltage	BVDSS	20	_	—	V	$V_{GS} = 0V, I_D = 250 \mu A$
Zero Gate Voltage Drain Current TJ = +25°C	IDSS	—		1	μA	$V_{DS} = 20V, V_{GS} = 0V$
Gate-Source Leakage	IGSS	—	—	±10	μA	$V_{GS} = \pm 10V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	Vgs(th)	0.5		1.0	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$
Static Drain-Source On-Resistance	Deserver			25	mΩ	$V_{GS} = 4.5V, I_D = 4A$
Static Drain-Source OII-Resistance	RDS(ON)	_		35	11152	V _{GS} = 2.5V, I _D = 4A
Diode Forward Voltage	V _{SD}	—	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 5A$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	Ciss	—	486	—		V _{DS} = 10V, V _{GS} = 0V, f = 1.0MHz
Output Capacitance	Coss	—	92	—	pF	
Reverse Transfer Capacitance	Crss	—	77	—		
Gate Resistance	Rg	—	3.2	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge (V _{GS} = 4.5V)	Qg	-	5.9	—		
Total Gate Charge (V _{GS} = 10V)	Qg	—	12.3	—	nC	
Gate-Source Charge	Q _{gs}	—	0.8	—	nc	$V_{DS} = 10V, I_{D} = 6.5A$
Gate-Drain Charge	Q _{gd}	—	2.2	—		
Turn-On Delay Time	t _{D(ON)}	—	3.4	—		
Turn-On Rise Time	tR	—	5.4	—		$V_{DS} = 10V, V_{GS} = 4.5V,$
Turn-Off Delay Time	td(OFF)	—	17.6		ns	$R_g = 6\Omega$, $R_L = 10\Omega$, $I_D = 1A$
Turn-Off Fall Time	tF	—	9.3			
Reverse Recovery Time	trr	—	7.7	_	ns	IF = 1A, di/dt = 100A/µs
Reverse Recovery Charge	Q _{RR}		1.5	_	nC	I _F = 1A, di/dt = 100A/µs

8. Short duration pulse test used to minimize self-heating effect.9. Guaranteed by design. Not subject to product testing. Notes:



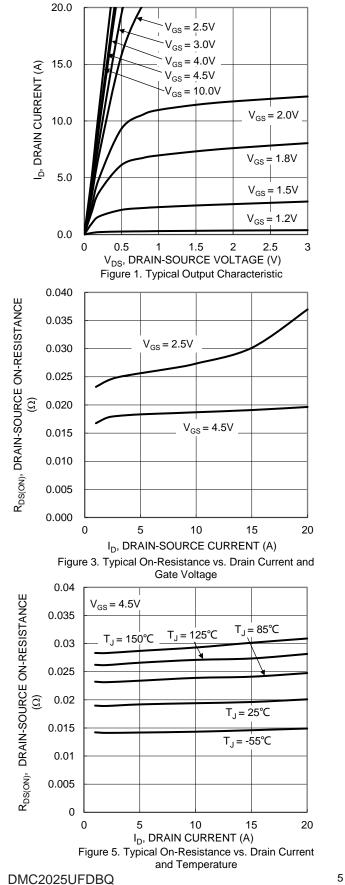
Electrical Characteristics Q2 P-CHANNEL (@ TA = +25°C, unless otherwise specified.)

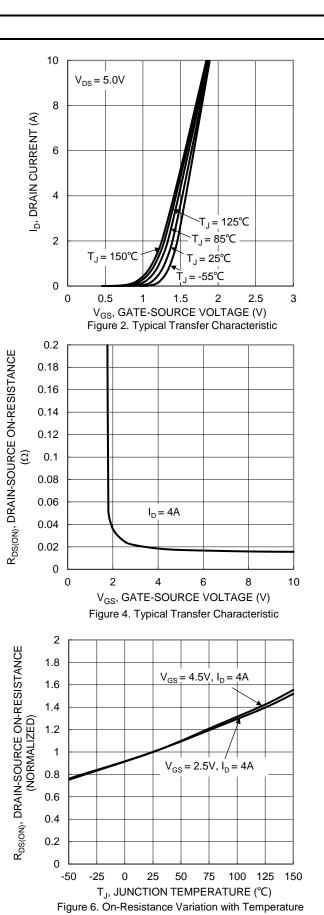
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)					•	
Drain-Source Breakdown Voltage	BVDSS	-20	—	—	V	$V_{GS} = 0V, I_{D} = -250 \mu A$
Zero Gate Voltage Drain Current T _J = +25°C	IDSS	—	—	-1.0	μA	VDS = -20V, VGS = 0V
Gate-Source Leakage	Igss	—	—	±10	μA	$V_{GS} = \pm 8V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS(TH)}	-0.35	—	-1.4	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$
Static Drain-Source On-Resistance	Deserve	—		75	mΩ	$V_{GS} = -4.5V, I_D = -2.9A$
	Rds(on)	—	—	140	1111.2	V_{GS} = -2.5V, I_D = -2.3A
Diode Forward Voltage	Vsd	—	—	-1.2	V	V _{GS} = 0V, I _S = -3.0A
DYNAMIC CHARACTERISTICS (Note 9)		•				·
Input Capacitance	Ciss		642		pF	
Output Capacitance	Coss	—	98	—	pF	$V_{DS} = -10V, V_{GS} = 0V,$ - f = 1.0MHz
Reverse Transfer Capacitance	Crss	—	87	—	pF	
Gate Resistance	Rg	—	26.5		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge (V _{GS} = -4.5V)	0	—	8.8	—	nC	
Total Gate Charge (V _{GS} = -8V)	— Qg		15		nC	
Gate-Source Charge	Qgs	—	0.9	_	nC	$V_{DS} = -10V, I_{D} = -3.7A$
Gate-Drain Charge	Q _{gd}	—	2.9	_	nC	
Turn-On Delay Time	t _{D(ON)}	—	5.5		ns	
Turn-On Rise Time	t _R	—	22.6		ns	VDD = -10V, VGS = -4.5V,
Turn-Off Delay Time	tD(OFF)		34.1	_	ns	$R_L = 3.3\Omega, R_g = 1\Omega$
Turn-Off Fall Time	tF		34.3	_	ns	
Body Diode Reverse Recovery Time	t _{RR}	—	13	_	ns	I _S = -3.0A, dl/dt = 100A/µs
Body Diode Reverse Recovery Charge	Q _{RR}	_	3.3	_	nC	Is = -3.0A, dl/dt = 100A/µs

Notes: 8. Short duration pulse test used to minimize self-heating effect. 9. Guaranteed by design. Not subject to product testing.



Typical Characteristics - N-CHANNEL

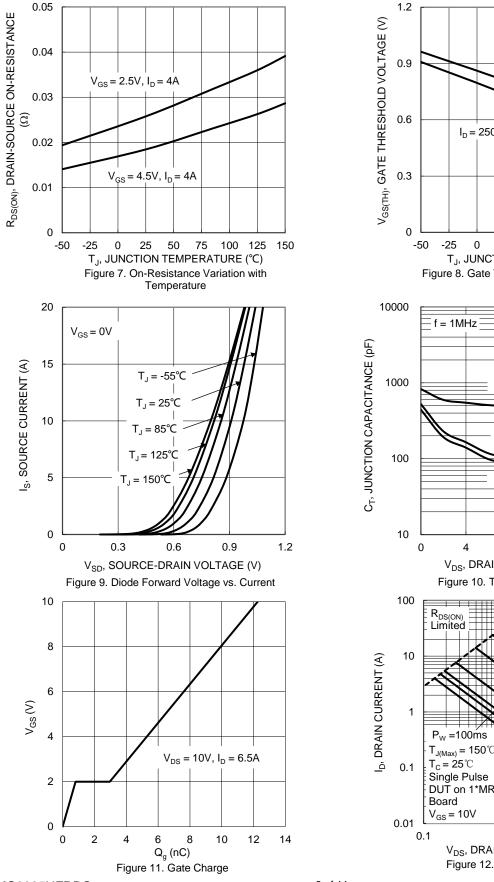




DMC2025UFDBQ Document number: DS42696 Rev. 2 - 2



Typical Characteristics - N-CHANNEL (continued)



 $I_D = 1mA$ $I_{D} = 250 \mu A$ 25 50 75 100 125 150 T_J, JUNCTION TEMPERATURE (°C) Figure 8. Gate Threshold Variation vs. Junction Temperature Ciss C C_{rss} 8 12 16 20 V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 10. Typical Junction Capacitance =100µs =1ms _w =10ms T_{J(Max)} = 150℃ P_{W} =1s DUT on 1*MRP P_{W} =10s

> 1 10 100 V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area

DC

DMC2025UFDBQ Document number: DS42696 Rev. 2 - 2



T, = 125℃

2

2.5

3

8

7

6

T₁ = 85°C

T」= 25℃

-55°C

1.5

1

 $I_{D} = -2.3A$

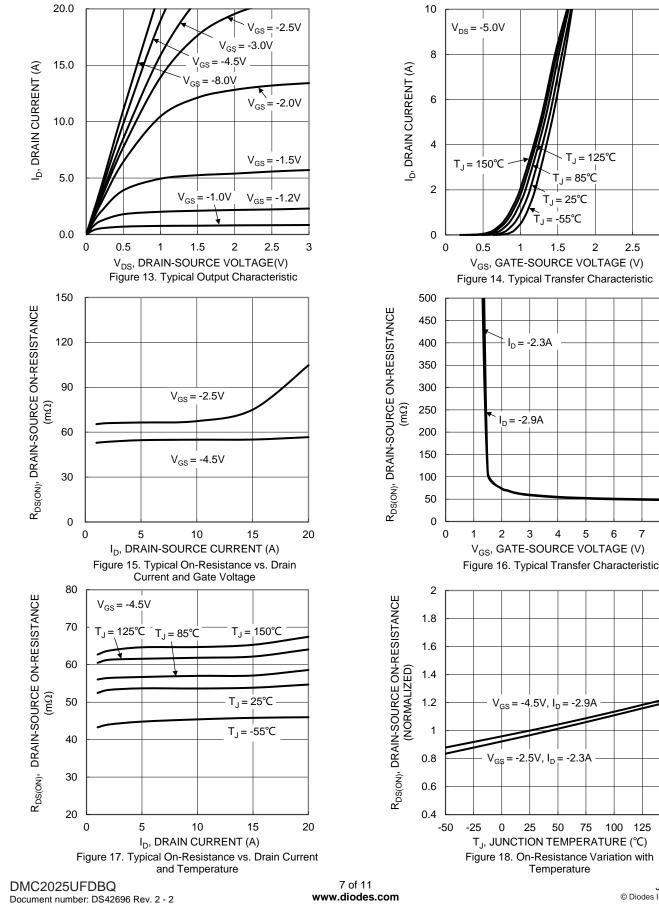
3

4

5

= -2.9A

Typical Characteristics - P-CHANNEL



50

Temperature

75

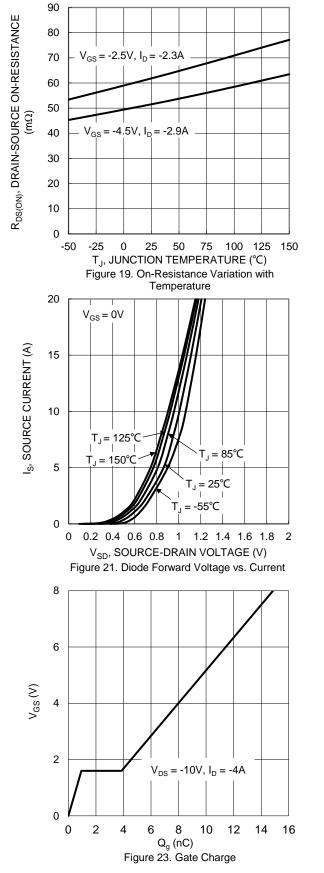
100 125

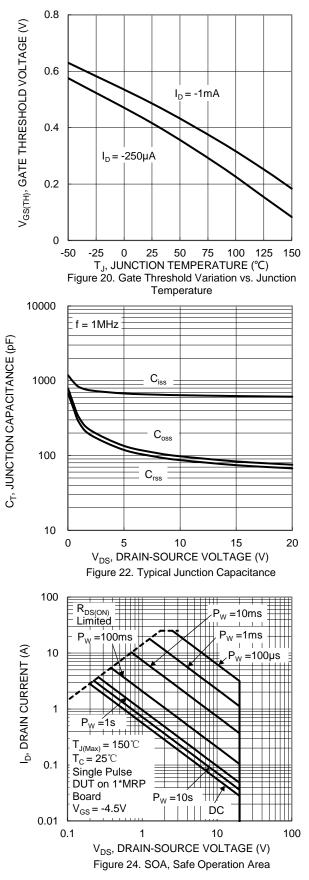
25

150



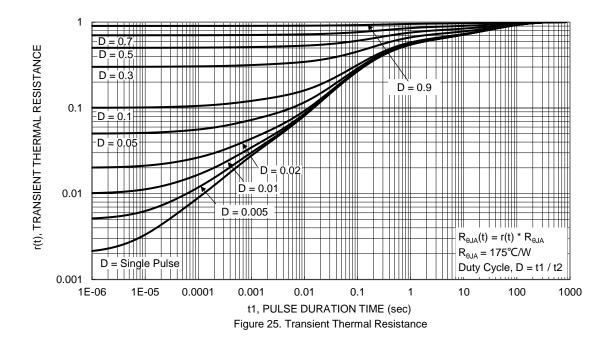
Typical Characteristics - P-CHANNEL (continued)





DMC2025UFDBQ Document number: DS42696 Rev. 2 - 2

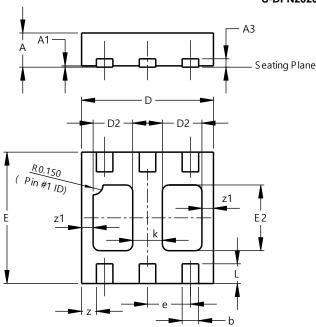






Package Outline Dimensions

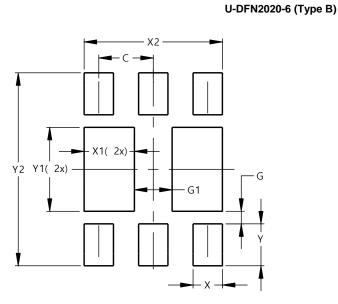
Please see http://www.diodes.com/package-outlines.html for the latest version.



U-DFN2020-6 Type B						
Dim	Min	Max	Тур			
Α	0.545	0.605	0.575			
A1	0.00	0.05	0.02			
A3	-	-	0.13			
b	0.20	0.30	0.25			
D	1.95	2.075	2.00			
D2	0.50	0.70	0.60			
е	-	-	0.65			
E	1.95	2.075	2.00			
E2	0.90	1.10	1.00			
k	-	-	0.45			
L	0.25	0.35	0.30			
z	-	-	0.225			
z1	-	-	0.175			
All	Dimens	ions in	mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	0.650
G	0.150
G1	0.450
Х	0.350
X1	0.600
X2	1.650
Y	0.500
Y1	1.000
Y2	2.300

U-DFN2020-6 (Type B)



IMPORTANT NOTICE

1. DIODES INCORPORATED AND ITS SUBSIDIARIES ("DIODES") MAKE NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO ANY INFORMATION CONTAINED IN THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

2. The Information contained herein is for informational purpose only and is provided only to illustrate the operation of Diodes products described herein and application examples. Diodes does not assume any liability arising out of the application or use of this document or any product described herein. This document is intended for skilled and technically trained engineering customers and users who design with Diodes products. Diodes products may be used to facilitate safety-related applications; however, in all instances customers and users are responsible for (a) selecting the appropriate Diodes products for their applications, (b) evaluating the suitability of the Diodes products for their intended applications, (c) ensuring their applications, which incorporate Diodes products, comply the applicable legal and regulatory requirements as well as safety and functional-safety related standards, and (d) ensuring they design with appropriate safeguards (including testing, validation, quality control techniques, redundancy, malfunction prevention, and appropriate treatment for aging degradation) to minimize the risks associated with their applications.

3. Diodes assumes no liability for any application-related information, support, assistance or feedback that may be provided by Diodes from time to time. Any customer or user of this document or products described herein will assume all risks and liabilities associated with such use, and will hold Diodes and all companies whose products are represented herein or on Diodes' websites, harmless against all damages and liabilities.

4. Products described herein may be covered by one or more United States, international or foreign patents and pending patent applications. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks and trademark applications. Diodes does not convey any license under any of its intellectual property rights or the rights of any third parties (including third parties whose products and services may be described in this document or on Diodes' website) under this document.

5 provided subject to Diodes' Standard Terms and Conditions of Sale Diodes products are (https://www.diodes.com/about/company/terms-and-conditions/terms-and-conditions-of-sales/) or other applicable terms. This document does not alter or expand the applicable warranties provided by Diodes. Diodes does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel.

6. Diodes products and technology may not be used for or incorporated into any products or systems whose manufacture, use or sale is prohibited under any applicable laws and regulations. Should customers or users use Diodes products in contravention of any applicable laws or regulations, or for any unintended or unauthorized application, customers and users will (a) be solely responsible for any damages, losses or penalties arising in connection therewith or as a result thereof, and (b) indemnify and hold Diodes and its representatives and agents harmless against any and all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim relating to any noncompliance with the applicable laws and regulations, as well as any unintended or unauthorized application.

7. While efforts have been made to ensure the information contained in this document is accurate, complete and current, it may contain technical inaccuracies, omissions and typographical errors. Diodes does not warrant that information contained in this document is error-free and Diodes is under no obligation to update or otherwise correct this information. Notwithstanding the foregoing, Diodes reserves the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes.

8. Any unauthorized copying, modification, distribution, transmission, display or other use of this document (or any portion hereof) is prohibited. Diodes assumes no responsibility for any losses incurred by the customers or users or any third parties arising from any such unauthorized use.

Copyright © 2021 Diodes Incorporated

www.diodes.com